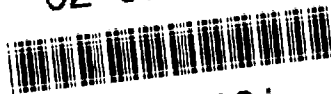


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U.S. Department of Commerce  
Patents & Trademark Office

Attorney Docket No. P1190-9003

Date: January 22, 1999

511 U.S. PTO  
09/236229

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The Honorable Commissioner of Patents and Trademarks:  
Please record the attached original documents or copy thereof

1. Name of conveying party(ies)

Byung-Kyu PARK; Hyo-Bong KIM; Koon-Sup OH; Joon-Sik LEE

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: KOREA INSTITUTE OF MACHINERY & MATERIALS

Internal Address: \_\_\_\_\_

Street Address: 171, Jang-Dong, Yoosung-Ku,  
Daejeon-Si, Korea

City: \_\_\_\_\_ State: \_\_\_\_\_ Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?

☐ Yes ☒ No

3. Nature of conveyance:

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Execution Date: January 6, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: January 6, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

NIKAIDO, MARMELESTEIN, MURRAY & ORAM LLP

Internal Address: \_\_\_\_\_

Street Address: Metropolitan Square, 655 15th St., N.W.,

Suite 330 - G Street Lobby

City: Washington State: DC Zip: 20005-5701

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41)..... \$ 40.00

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David T. Nikaido  
Name of Person Signing  
Reg. No. 22,663

Signature

January 22, 1999  
Date

Total number of pages including cover sheet, attachments and document: 2

Docket No. \_\_\_\_\_

**U.S. ASSIGNMENT**

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by  
KOREA INSTITUTE OF MACHINERY & MATERIALS

171, Jang-Dong, Yoosung-Ku, Daejeon-Si, Korea

[Insert  
ASSIGNEE's  
Name(s)  
Address(es)]

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

High efficiency modular OLF heat exchanger with heat  
transfer enhancement

[Title of  
Invention]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

\*filed on \_\_\_\_\_, Serial No. \_\_\_\_\_

(Nikaido, Marmelstein, Murray & Oram is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s)]

  
(SIGNATURE)

Byung-Ku PARK

(TYPE NAME)

Jan. 6, 1999

(DATE)

  
(SIGNATURE)

Hyo-Bong KIM

(TYPE NAME)

Jan. 6, 1999

(DATE)

  
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Koon-Sup OH

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Jan. 6, 1999

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Joon-Sik LEE

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Jan. 6, 1999

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**PATENT** (DATE)